

Harvatek Surface Mount LED Data Sheet HT-121UYG-4739

Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 1/19



DISCLAIMER	3
PRODUCT SPECIFICATIONS	4
ATTENTION: ELECTROSTATIC DISCHARGE (ESD) PROTECTION	5
LABEL SPECIFICATIONS	6
PRODUCT CHARACTERISTICS	9
ABSOLUTE MAXIMUM RATINGS	9
ELECTRO-OPTICAL CHARACTERISTICS	9
PACKAGE OUTLINE DIMENSION	9
RECOMMENDED SOLDERING PATTERN FOR REFLOW SOLDERING	9
CHARACTERISTIC CURVES FOR UYG	10
CHARACTERISTIC CURVES FOR ALL COLORS (RADIATION PATTE	RN)11
PACKAGING	12
TAPE DIMENSION	
REEL DIMENSION	13
Packing	14
DRY PACK	15
REFLOW SOLDERING	16
WAVE SOLDERING	16
PRECAUTIONS	17
Reworking	17
CLEANING	17
RELIABILITY	18
REVISION HISTORY	19

Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******	HT-121UYG-4739		
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 2/19



DISCLAIMER

HARVATEK reserves the right to make changes without further notice to any products herein to improve reliability, function or design. HARVATEK does not assume any liability arising out of the application or use of any product or circuit described herein; neither does it convey any license under its patent rights, nor the rights of others.

LIFE SUPPORT POLICY

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

- 1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 3/19



Product Specifications

Product	Emission Color	Technology	Test Current I _F (mA)	Luminous Intensity I _V (mcd)	Forward Voltage V _F (V)	Orderable Part Number
HT-121UYG	Ultra Bright Yellow Green	AllnGaP	20	71.5 typ	2.0 typ	HT-121UYG-4739

Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 4/19



	Specification	Material	Quantity
Resin	Water clear	Epoxy resin	
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and

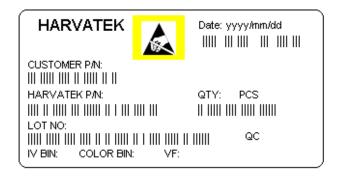
InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

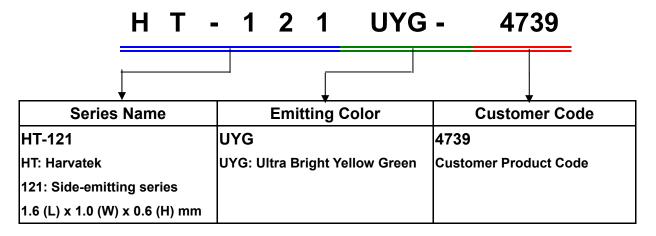
Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******	HT-121UYG-4739		
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 5/19



Label Specifications



■ Harvatek P/N:



Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 6/19



Lot No.:

1 2 3 4 5 6 7 8 9 10

P 1 2 2 3 0 A - D T

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
		1: Jan.				
	Z: 2000	2: Feb.				
Internal	1: 2001			04.00		
Tracing	2: 2002	9: Sep.	1~31/ (30)	01~99,	D: Diffused	T: Tape & Reel
Code	3: 2003	A: Oct.		A,B,C		
		B: Nov.				
		C: Dec.				

Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	********			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 7/19



■ Luminous Intensity (Iv) Bin:

Bin	Luminous Intens	sity Range (mcd)	Bin	Luminous Intensity Range (mcd)	
Biii	Minimum	Maximum	ווום	Minimum	Maximum
P1	45.0	57.0	P2	57.0	71.5
Q1	71.5	90.0	Q2	90.0	112.5

@20mA / Ta=25° C, Tolerance: <u>+</u> 10%

■ Wavelength (λ_D) Bin:

		· -/		
	Wavelength Range (nm)			
Bin	Yellow Green			
Diii	(UYG)			
	Min	Max		
-				
С	567.5	570.5		
D	570.5	573.5		
-				

@20mA / Ta=25° C, Tolerance: <u>+</u> 0.5nm

■ Forward Voltage (V_F) Bin:

Color	Bin Code	Spec. Range
	E5	1.6 – 1.8V
Ultra Bright	E6	1.8 – 2.0V
(UYG)	F5	2.0 - 2.2V
	F6	2.2 – 2.4V

@20mA / Ta=25 $^{\circ}$ C , Tolerance: $\underline{+}$ 0.05 V

Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject drawings herein are copy	t to change without notice. Data and righted.	Jan. 21, 2009	Version of 1.0	Page 8/19



Product Characteristics

Absolute Maximum Ratings

Product	Emission Color	P _d (mW)	I _F (mA)	I _{FP} * (mA)	V _R (V)	Top (°C)	T _{ST} (°C)
HT-121UYG	Ultra Bright Yellow Green	72	30	100	5	-30°C~+80°C	-40°C~+85°C

^{*} Condition for I_{FP} is pulse of 1/10 duty and 0.1 msec width

Electro-Optical Characteristics

(Ta 25 °C)

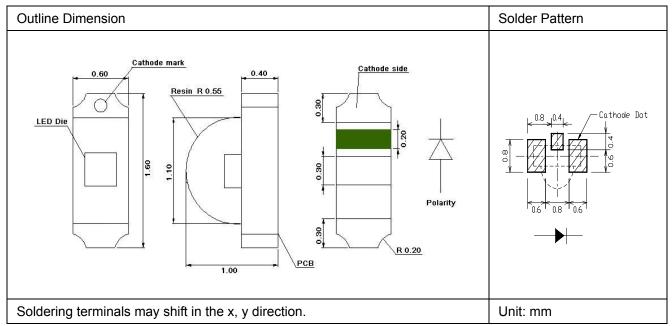
Product	Emission	I₅(mA)	V_{F}	(V)		λ(nm)		I* _∨ (n	ncd)
Product	Color		typ	max	λ_{D}	λ_{P}	Δλ	min	typ
HT-121UYG	Ultra Bright Yellow Green	20	2.0	2.4	573	574	20	45	71.5

^{*} Per NIST standards

Package Outline Dimension

Recommended Soldering Pattern for Reflow Soldering

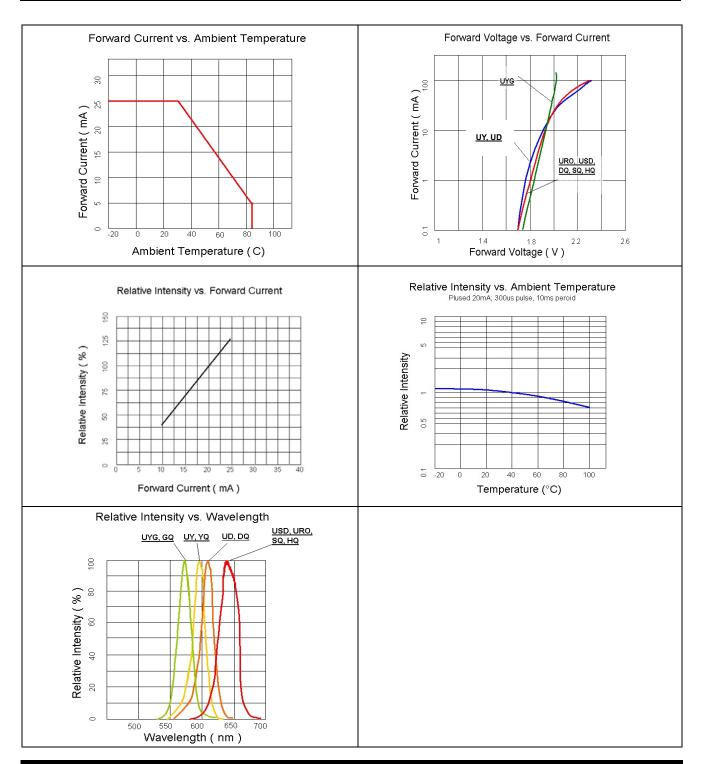
Unit: mm Tolerance: +/-0.1



Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 9/19



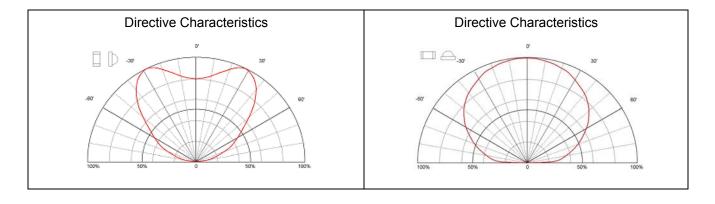
Characteristic Curves for UYG



Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 10/19



Characteristic Curves for All Colors (Radiation Pattern)

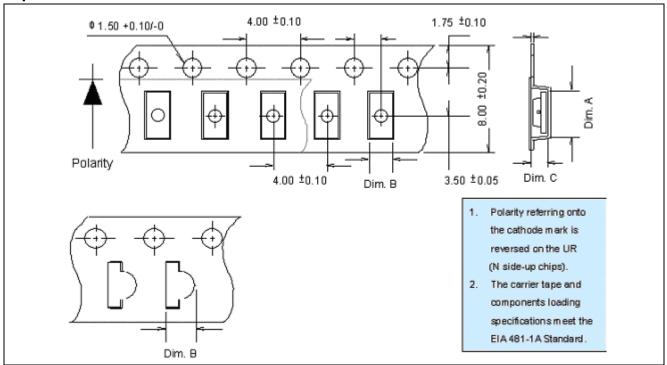


Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject drawings herein are copy	t to change without notice. Data and vrighted.	Jan. 21, 2009	Version of 1.0	Page 11/19



Packaging

Tape Dimension



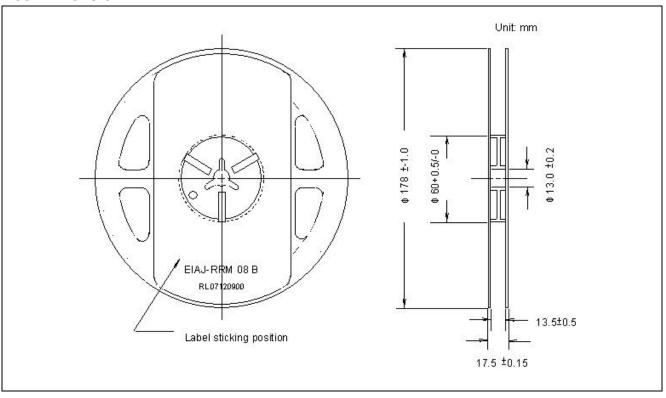
Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-121	1.90±0.10	1.15±0.10	0.80±0.10	4K

Unit: mm

Official Product	Product: HT-121UYG-4739	Data Sheet No.		
Tentative Product	******			HT-121UYG-4739
Specifications are subject drawings herein are copy	t to change without notice. Data and righted.	Jan. 21, 2009	Version of 1.0	Page 12/19



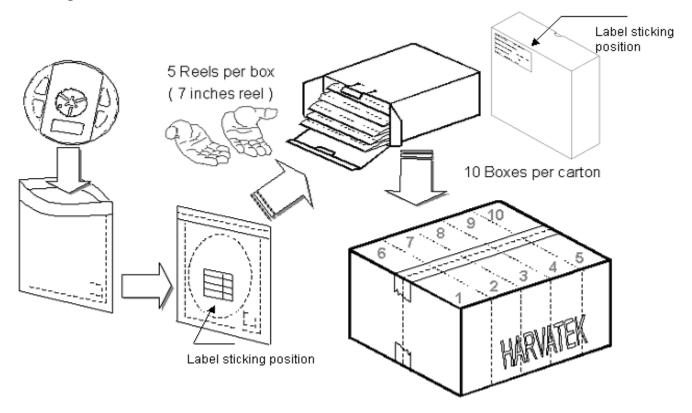
Reel Dimension



Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject drawings herein are copy	et to change without notice. Data and prighted.	Jan. 21, 2009	Version of 1.0	Page 13/19



Packing



5 boxes per carton is available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	4000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of Iv, λ_D and Vf. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 14/19

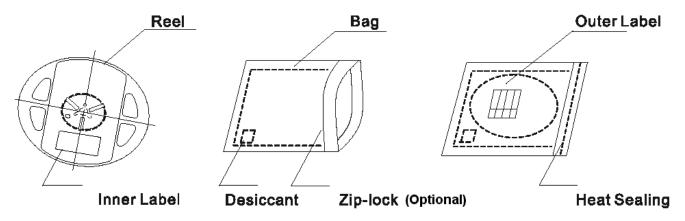


Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



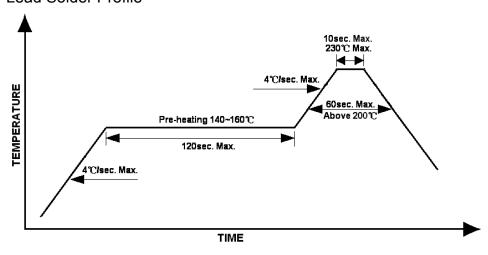
Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	********			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 15/19



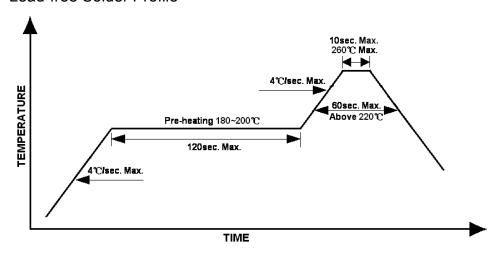
Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead Solder Profile



Lead-free Solder Profile



Wave Soldering

• Maximum soldering temperature is 260°C for 5 seconds.

Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	********			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 16/19



Precautions

- 1. Avoid exposure to moisture at all times during transportation or storage.
- 2. Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- 3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
- 4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
- 5. Avoid direct contact with the surface through which the LED emits light.
- 6. If possible, assemble the unit in a clean room or dust-free environment.

Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- · Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 17/19



Reliability

Item	Frequency/ lots/ samples/ failures	Standards Reference	Conditions
Precondition	For all reliability monitoring tests according to JEDEC Level 2	J-STD-020	1.) Baking at 85°C for 24hrs 2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	HT specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 μ s,T=1sec) Duration 500hrs)
Temperature cycle		JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type
High humidity	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
storage test			90+3/-10 /0 K.H. IOI 3001118
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs

Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 18/19



Revision History

Changes since last revision	Page	Version No.	Revision Date
New format 4739		1.0	01-21-2009

Official Product	Product: HT-121UYG-4739			Data Sheet No.
Tentative Product	*******			HT-121UYG-4739
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Jan. 21, 2009	Version of 1.0	Page 19/19